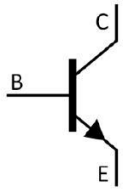
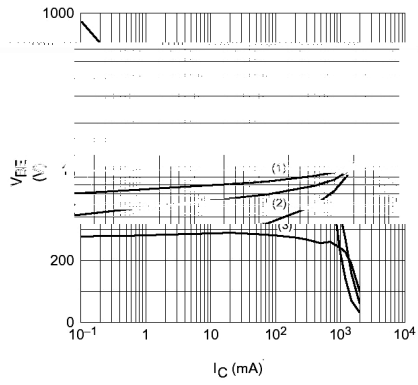


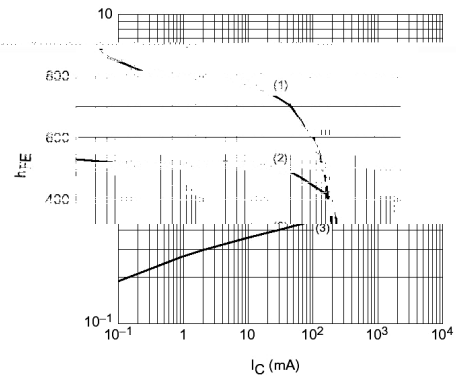
SOT-23 NPN



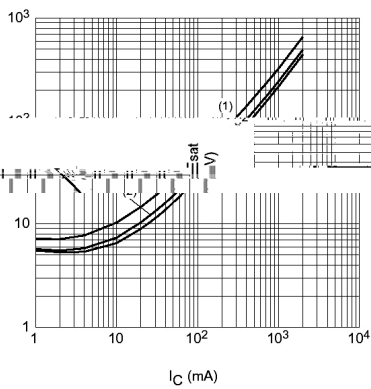
hFE-IC



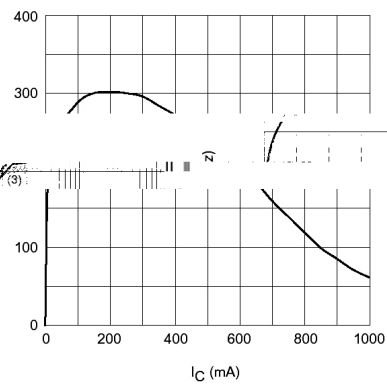
VBE-IC



VCE-IC

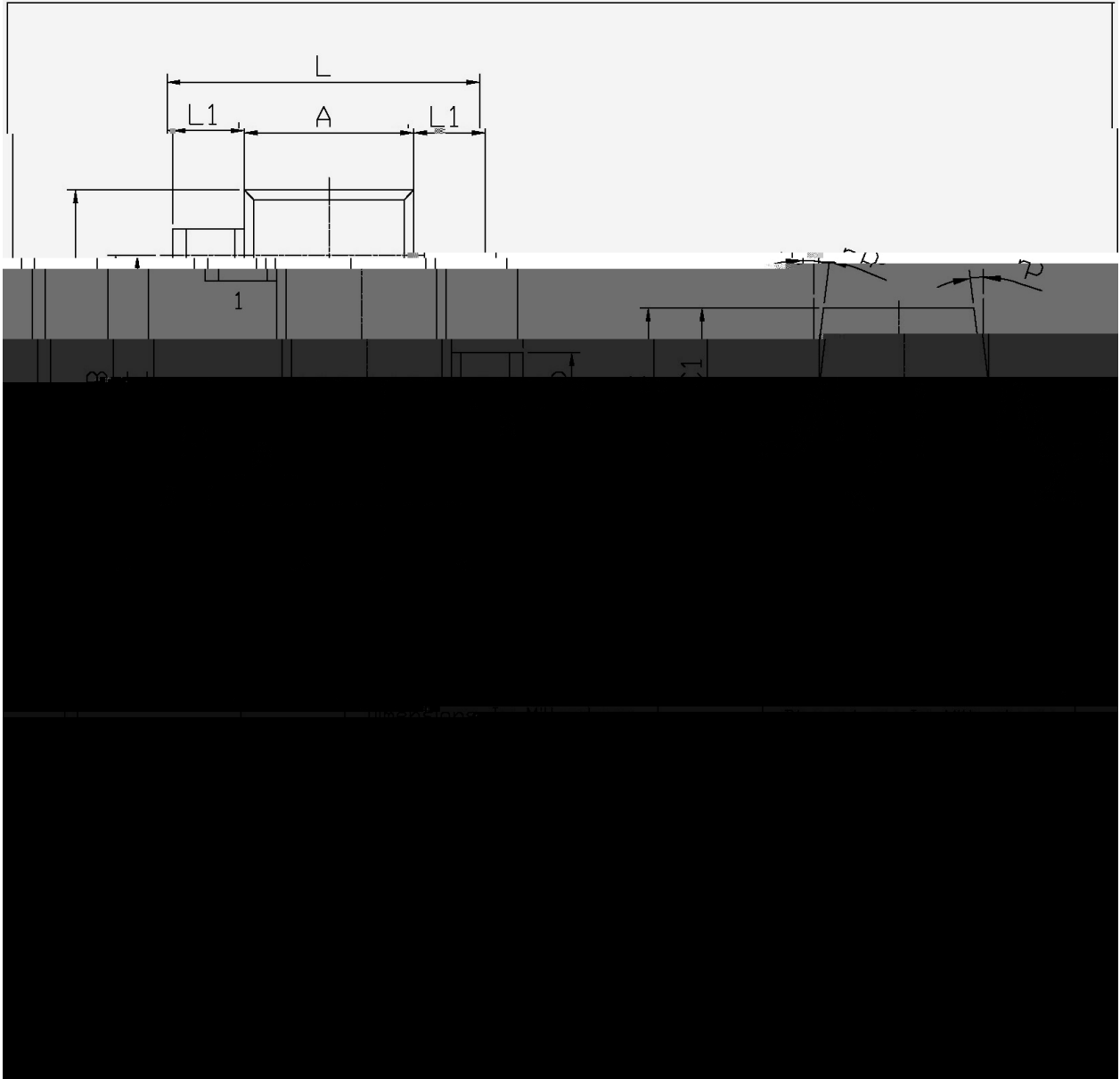


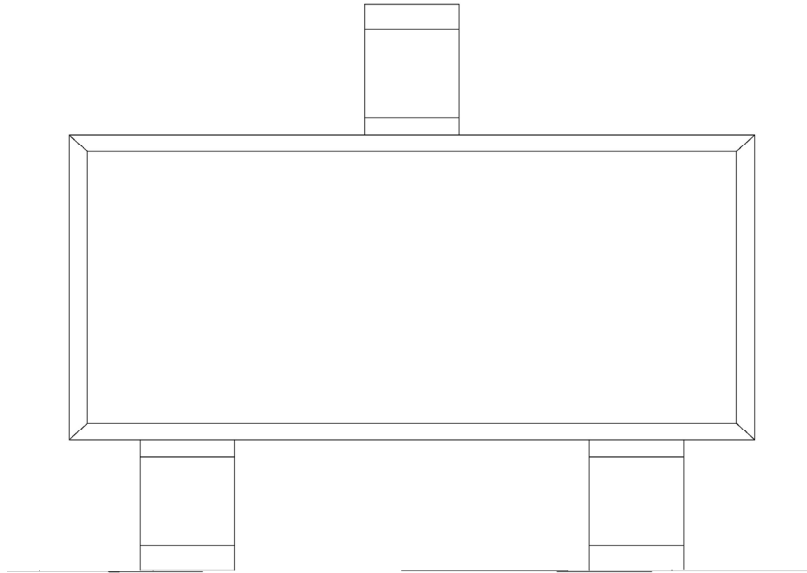
fT-IC



SOT-23

单位: mm

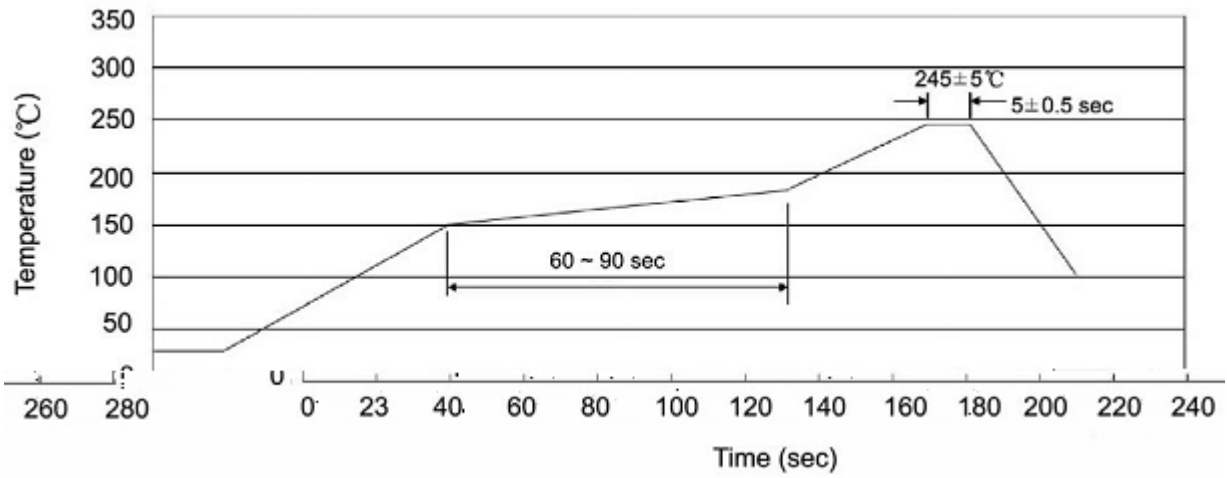




H

H

Temperature Profile for IR Reflow Soldering(Pb-Free)



±

±

±

±

±

±

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 × 8	180×120×180	390×385×205